Listing of Claims:

- 1. (Original) A handling means of high-frequency energy, which means comprises a dielectric board having at least two strip conductors, between which there is a coupling, at least one hole filled with conductive material and at least one resistive structural part, wherein the handling means form a monolithic piece.
- 2. (Original) A handling means according to Claim 1, wherein said dielectric board is ceramic, and said strip conductors have been processed on its surface.
- 3. (Original) A handling means according to Claim 2, wherein said resistive structural part is formed of said conductive material filling up a hole in the ceramic board.
- 4. (Original) A handling means according to Claim 2, wherein said resistive structural part is formed of material processed on the surface of the ceramic board and is in series with said conductive material filling up a hole in the ceramic board.
- 5. (Original) A handling means according to Claim 3, being a Wilkinson divider.
- 6. (Original) A handling means according to Claim 3, being a Wilkinson combiner.

- 7. (Original) A handling means of high-frequency energy, which means comprises a multilayer dielectric board having at least two strip conductors, between which there is an electromagnetic coupling, wherein the handling means forms a monolithic piece, and at least two conductors of said strip conductors are located in different interlayers of the multilayer board on top of each other to arrange said electromagnetic coupling.
- 8. (Original) A handling means according to Claim 7, wherein on two surfaces of said multilayer board there is a conductive plane so that said strip conductors are in the layers between these planes to form transmission lines suitable for TEM waves.
 - 9. (Original) A handling means according to Claim 8, being a Lange coupler.
- 10. (previously presented) A handling means according to Claim 4, being a Wilkinson divider.
- 11. (previously presented) A handling means according to Claim 4, being a Wilkinson combiner.
 - 12. (new) A high frequency splitter/combiner comprising:
 - a board having two opposing planar sides;
- a plurality of strip conductors arranged on one side of said board and coupled to each other;

a plurality of resistive structural parts corresponding respectively to said plurality of strip conductors and arranged on the other side of said board, said board defining holes therethrough filled with conductive material, each of said holes connecting one of said plural strip conductors with a respective one of said plural resistive structural parts.